

**General Description**

The CMSA025N03 uses advanced technology to provide excellent RDS (ON) . This device is suitable to be used as the low side FET general purpose.

**Features**

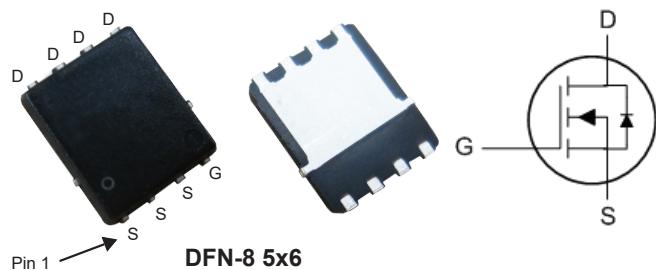
- RDS(ON)<2.5mΩ @ VGS=10V
- 100% avalanche tested
- RoHS and Halogen-Free Compliant
- High Current Capability

**Absolute Maximum Ratings****Product Summary**

BVDSS	RDS(on)	ID
30V	2.5mΩ	100A

**Applications**

- DC/DC Converters in Computing, Servers, and POL
- Isolated DC/DC Converters in Telecom and Industrial

**DFN-8 5x6 Pin Configuration**

Type	Package	Marking
CMSA025N03	DFN-8 5*6	CMSA025N03

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	40	V
V <sub>GS</sub>	Gate-Source Voltage	±16	V
I <sub>D</sub> @T <sub>c</sub> =25°C	Continuous Drain Current	100	A
I <sub>D</sub> @T <sub>c</sub> =100°C	Continuous Drain Current	80	A
I <sub>DM</sub>	Pulsed Drain Current	400	A
EAS	Single Pulse Avalanche Energy	390	mJ
P <sub>D</sub> @T <sub>c</sub> =25°C	Total Power Dissipation	85	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C

**Thermal Data**

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	---	50	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction -Case	---	1.5	°C/W

## N-Channel Enhancement Mode Field Effect Transistor

Electrical Characteristics ( $T_J=25^\circ\text{C}$  , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	30	---	---	V
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$ , $I_D=50\text{A}$	---	---	2.5	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_D=40\text{A}$	---	---	3.7	
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D = 250\mu\text{A}$	1	---	3	V
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=24\text{V}$ , $V_{\text{GS}}=0\text{V}$	---	---	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}} = \pm 16\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_D=20\text{A}$	---	20	---	S
$R_g$	Gate Resistance	$V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	3.2	---	$\Omega$
$Q_g$	Total Gate Charge	$V_{\text{DD}}=15\text{V}$ , $I_D=30\text{A}$	---	28	---	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	13	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	7	---	
$T_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DD}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_D=30\text{A}$	---	11	---	ns
$T_r$	Rise Time		---	6	---	
$T_{\text{d}(\text{off})}$	Turn-Off Delay Time		---	37	---	
$T_f$	Fall Time		---	7	---	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	2300	---	pF
$C_{\text{oss}}$	Output Capacitance		---	750	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	34	---	

## Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Diode continuous forward current	$V_G=V_D=0\text{V}$ , Force Current	---	---	100	A
$I_{s,\text{pulse}}$	Diode pulse current		---	---	400	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_F=28\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1.2	V

Note :

This product has been designed and qualified for the consumer market.  
 Cmos assumes no liability for customers' product design or applications.  
 Cmos reserves the right to improve product design ,functions and reliability without notice.